



<p>1. Insulator material: N=PA6T L=LCP P=PA9T 2. Circuits: 4-50PIN 3. Tail Style: S0=180° 4. Color: BK=Black</p> <p>5. Contact Plated: T=Matte Tin over Nickel W=Matte Tin over nickel V=Bright Tin over Nickel F=Gold Flash, Matte Tin 100µ" A=Gold 3µ" B=Gold 3µ" C = ordinary gold plating D=Gold 5µ" V=Gold 30µ"</p> <p>6. Special Options: 7. Packing: A=Bag B=Tube C=Tray E=Cap+Reel F=Cap+tube G=Cap+tray H=Cap+bag N=Tap&reel</p> <p>(RoHS Compliant)</p> <p>BH22 X - XX S0 BK X 000 X</p> <p>1 2 3 4 5 6 7</p>					
<p>1. BH22N-XXBK40C2</p> <p>2. SQ0.50-8-50-X-C12</p> <p>3.</p> <p>东莞市震升电子有限公司 DONG GUAN ZHEN SHENG ELECTRONICS CO., LTD</p> <p>TEL:0769-85305015 FAX:0769-85845060</p>	<p>PART NO. BH22X-XXS0BKX000X</p> <p>DRAWING NO. ZS-00017-J</p> <p>DRAWN BY Deng jin quan</p> <p>APPROVAL BY Chen xiao guang</p>	<p>Recommended P.C. Board SMD Layout</p> <p>2.00</p> <p>2.0*No.of Contacts/2-2.0</p> <p>Ø0.80</p>	<p>Dim.A 2.50</p>	<p>Current Rating: 2 Amps</p> <p>Insulator Resistance: 1000 Megohms min</p> <p>Dielectric Withstanding: AC 500V</p> <p>Contact Resistance: 20mΩ MAX</p> <p>Operation Temperature: -40~+105°C</p> <p>Max processing temp: 230°C for 60seconds</p> <p>Max processing temp: 260°C for 10seconds</p> <p>Contact Material: Brass</p> <p>Insulator material: Standard: Polyester, UL 94V-0</p> <p>Standard: PA9T</p> <p>Finish: Tin Gold Plated</p> <p>Standard: Gold Flash all over</p>	